Tiel .	<b>ber:</b> 2	022020	8002.0	PC	NI	Date:	February 17, 2022
		nware a	are and Datasheet change				
Customer	Contact:	PCN	Manager	De	pt	1	Quality Services
Change T	vpe:						
	mbly Site		Assembly Process			Assem	bly Materials
Desic			Electrical Specification		٦		nical Specification
Test			Packing/Shipping/Labeling		1		rocess
	r Bump Site		Wafer Bump Material				Bump Process
	r Fab Site		Wafer Fab Materials	Ī	1		Fab Process
			Part number change				
		• <u> </u>	PCN Details				
Descriptio	on of Change:						
family of d The chang	evices. Affected c	devices age mo	and update to the NVM con are listed in the Product Af nitoring (VMON) masking t latasheet, NVM_CODE_2, is	fecte	d s aft	section o er Analo	of this document. g Built-In Self-Test
TEXAS	5	being uj	pdated as summarized belo	w.			
V INSTE www.ti.com	RUMENTS		SLV	SEA7B	– D	ECEMBER 2	TPS6594-Q 019 – REVISED FEBRUARY 202
Changes f	om Revision A (Ap	ril 2021)	to Revision B (February 2022	2			Page
	0-mA to 3/0-mA) na	rameter		n 200 para	am	eter 4 131	(from 400-mA to 310-
<ul> <li>mA), part (from 33 mA)</li> <li>Added d</li> <li>BUCK R</li> <li>Added s</li> </ul>	rameter 4.132 (from 5-mA to 290-mA), pa lescription about OVC Regulator Overview: a ection: BUCK Regula	170-mA t arameter GDRV - V added Cu	4.123 (from 150-mA to 30-mA) o 290-mA), parameter 4.133 (fr 4.152 (from 150-mA to 230-mA /SYSSENSE relation /rrent Limit and Short-to-Ground ent Limit	, para rom 2 (), par d Dete	30 ran ect	-mA to 20 neter 4.15 ion on SV	0-mA), parameter 4.151 53 (from 185-mA to 50- 18 47 V_Bx pins
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•	Added note which explains the I <sup>2</sup> C addresses for each register map page on the I <sup>2</sup> C bus. Added note w	hich
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The datasheet number will be changing.

	New	
Product Family	Datasheet Number	Datasheet Number
TPS6594-Q1	SLVSEA7A	SLVSEA7B

These changes may be reviewed at the datasheet links provided: http://www.ti.com/product/TPS6594-01

## **Reason for Change:**

Improved device functionality

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

None.

**Product Affected:** 

Group 1 – Firmware and Datasheet updates:

TPS65941111RWERQ1 TPS65941212RWERQ1

Group 2 - Datasheet update only:

TPS65941213RWERQ1

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